



1. BERYLLIUM COPPER 190 HM 0.125 THICK
2. FINISH: NICKEL UNDERPLATE 1.0/3.0 MICRONS
3. PRE-LOAD FORCE: 0.50 N @ CONTACT POINT
4. FORCE @ MAXIMUM DEFLECTION: 0.73 N @ CONTACT POINT
5. MAXIMUM BEAM DEFLECTION: 0.80mm @ CONTACT POINT
6. CRITICAL DIMENSIONS ARE RINGED.
7. DIMENSIONS MARKED (SPC) ARE SUBJECT TO SPC CONTROL.
8. 3600 PCS ONE REEL WITH 100 LEADER EMPTY POCKETS AND 100 TRAILER EMPTY POCKETS. REEL OUTER DIMETER IS Ø330mm, REEL HUB DIMETER IS Ø100mm.
9. RECOMMENDED PCB PAD SIZE: 3.36 X 1.10 mm

BURR AROUND SOLDER PAD MAX 0.01

DO NOT SCALE						PDM:		A3/B	
Drawn	LL	10-May-06	Material: BERYLLIUM COPPER 190 HM - 0.125 ± 0.004 THICK	3rd ANGLE PROJECTION	ITT Industries	Toupandun Industrial Area, Jinda Cheng, Xiner Village, Shajing Town, Baoan District, Shenzhen City PRC 518125		Pro/E Generic Model	
Checked	KT	10-May-06						Title	MICRO UNIVERSAL CONTACT 4.0 mm
Engineer	LL	10-May-06	Treatment:	Surface Roughness	Cannon Electronics (SZ) Co. Ltd.	Ref:	Scale 10.000	Sheet 1 of 1	Drwg. No. CU-120220-0206
Manufact.									
Assembly			Dimensions in:	Cust Spec No:					
Quality									
Approvals	Sign	Date	This is issued in strict confidence on condition that it is not used as a basis for manufacture or sale and that it is not copied reprinted or disclosed to a third party either wholly or in part without the prior written consent of ITT Industries © 30-Mar-05						